505304859 01/30/2019

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
TAKASHI KOYAMA	01/17/2019

RECEIVING PARTY DATA

Name:	SZ DJI TECHNOLOGY CO., LTD.
Street Address:	17/F WEST WING SKYWORTH SEMICONDUCTOR DESIGN BLDG.
Internal Address:	NO. 18 GAOXIN SOUTH 4TH AVENUE, NANSHAN DISTRICT
City:	SHENZHEN
State/Country:	CHINA
Postal Code:	518057

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	16262573

CORRESPONDENCE DATA

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using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

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ATTORNEY DOCKET NUMBER:	00203.1426.00US
NAME OF SUBMITTER:	TINGLI WANG
SIGNATURE:	/Tingli Wang/
DATE SIGNED:	01/30/2019

Total Attachments: 2

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PATENT 505304859 REEL: 048194 FRAME: 0363

the Assignee, its successors and assigns.

ASSIGNMENT

WHEREAS I/We, the below named inventor(s) (hereinafter referred to as Assignor(s)) have made an invention entitled:
MOVABLE OBJECT AND METHOD FOR MANUFACTURING PHOTOGRAPHING DEVICE
for which I/We executed an application for United States Letters Patent herewith, as a national application in the United States of PCT Application No. <u>PCT/JP2016/073264</u> , or filed an application for United States Letters Patent on(Application No); and
WHEREAS, <u>SZ DJI TECHNOLOGY CO., LTD.</u> , a limited company of <u>P.R.China</u> , whose post office address is <u>17/F West Wing Skyworth Semiconductor Design Bidg.</u> , <u>No. 18 Gaoxin South 4th Avenue, Nanshan District, Shenzhen, Guangdong, <u>518057</u>, <u>P.R. China</u> (hereinafter referred to as Assignee), is desirous of securing the entire right, title, and interest in and to this invention in United States, and in and to the application for United States Letters Patent on this invention and the Letters Patent to be issued upon this application;</u>
NOW THEREFORE, be it known that, for good and valuable consideration the receipt of which from Assignee is hereby acknowledged, I/We, as Assignor(s), have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the Assignee, its lawful successors and assigns, my/our entire right, titte, and interest in and to this invention, provisional Application No
AND, I/WE HEREBY covenant that I/We have the full right to convey the interest assigned by this Assignment, and I/We have not executed and will not execute any agreement in conflict with this Assignment;
AND, I/WE HEREBY further covenant and agree that I/We will, without further consideration, communicate with Assignee, its successors and assigns, any facts known to me/us respecting this invention, and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver any and all papers that may be necessary or desirable to perfect the title to this invention in said Assignee, its successors or assigns, execute all divisional, continuation, and reissue applications, make all rightful caths and generally do everything possible to aid Assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States and any foreign country, it being understood that any expense incident to the execution of such papers shall be borne by

AND, I/WE HEREBY authorize and request the attorneys I/we have empowered in the Declaration and Power of Attorney in this application, to insert here in parentheses (Application No._____, filed ______) the filing date and application number of said application when known.

IN TESTIMONY WHEREOF, I/We have hereunto set our hands.

Inventor 1:

Name:

Takashi KOYAMA

Address:

c/o DJI Japan Kabushiki Kaisha, 9F, Tradepia

Odaiba, 2-3-1, Daiba, Minato-ku,

Tokyo, Japan 1350091

Signature:

Takashi. Koyama

Date:

January 17, 2019